

# Gain suppression mechanism observed in Low Gain Avalanche Detectors



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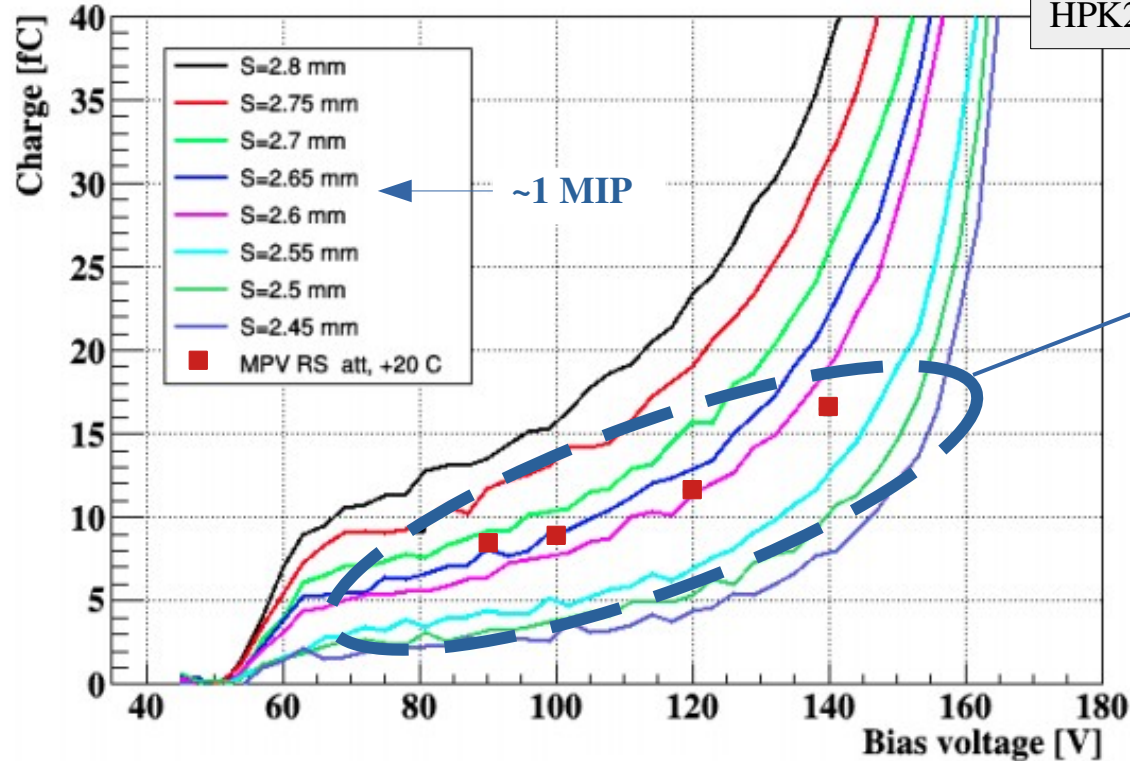


- Motivation: better understanding of gain and timing studies performed with TCT IR-laser and Sr-90 source.
- Comparison between IR-laser and Sr-90 measurements.
- Gain suppression mechanism with IR-laser:
  - ▷ Gain suppression in LGADs with different type of gain layers.
  - ▷ Gain suppression in irradiated LGADs.
- Gain suppression mechanism with Sr-90 source.
- Summary.

*For more details see also:  
"E.Curras et al, 16th (Virtual) "Trento" Workshop on Advanced Silicon Radiation Detectors"*

# Motivation: understand the differences between Sr-90 and IR-laser measurements

IR-laser at different power intensities vs Sr-90 source



## LGADs:

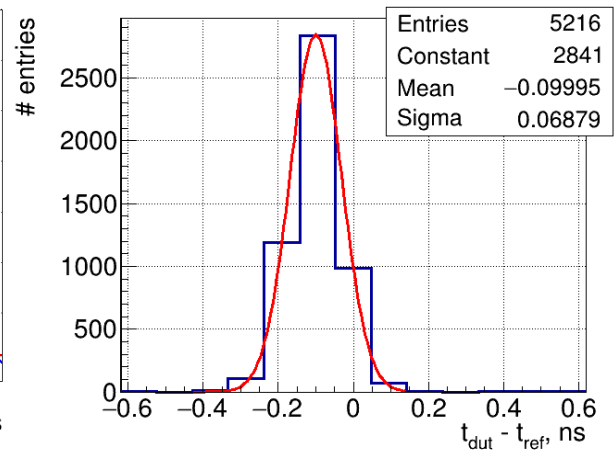
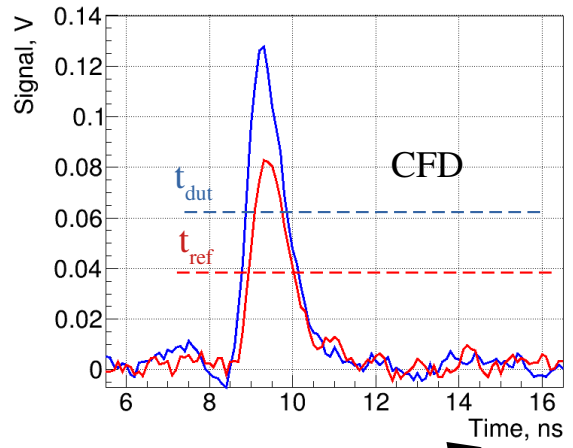
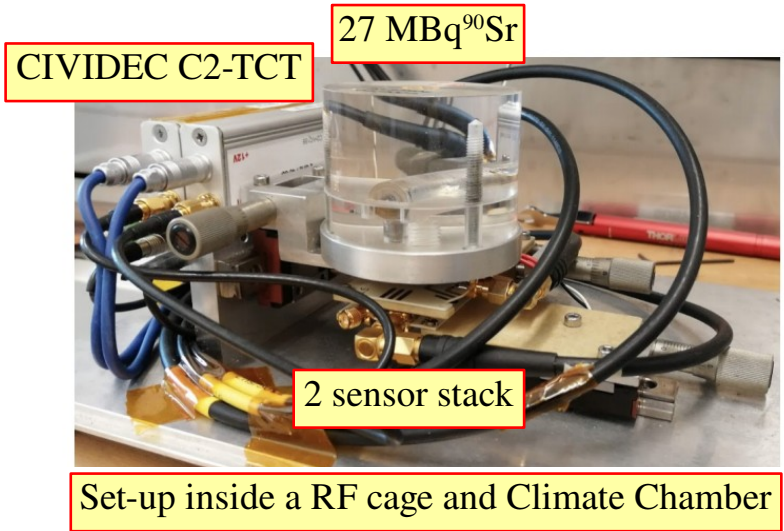
- Can we compare IR-laser measurements with Sr-90 ones: charge, gain, timing ...?
- Is there any IR-laser setting that will induce the same charge than the Sr-90 source ?

Value of shutter “S” is proportional to the laser power.

LGADs used:

HPK2 and CNM-12916 (1.3x1.3 mm<sup>2</sup> x 50 um).

# Gain and timing measurements with Sr-90

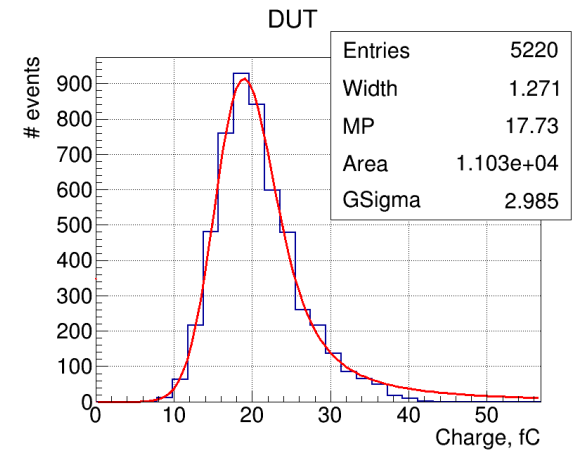


System time resolution:  $\sigma_{\text{sys}}^2 = \sigma_{\text{dut}}^2 + \sigma_{\text{ref}}^2$

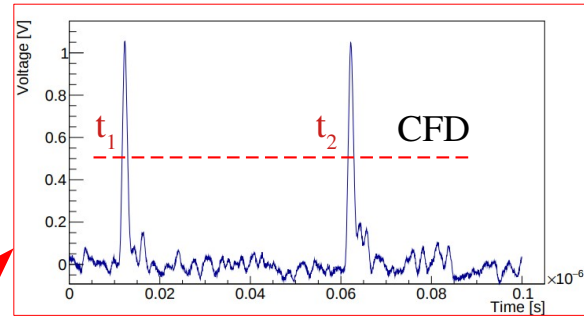
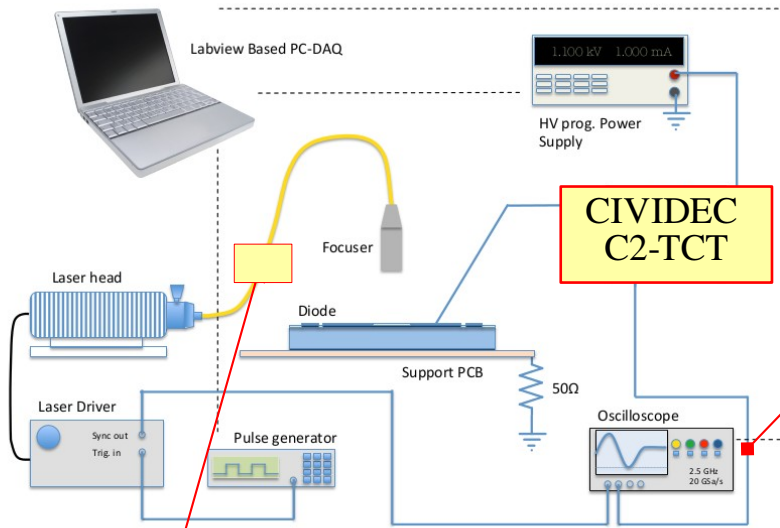
Gain definition:  $G(V) = Q(V)_{\text{LGAD}} / Q_{\text{PIN}}$

$Q_{\text{PIN}}$  measured:  $\sim 0.5$  fC for a 50  $\mu\text{m}$  thick PIN.

$Q(V)_{\text{LGAD}}$  is the MPV of the charge distribution.



# Gain and timing measurements with IR-laser

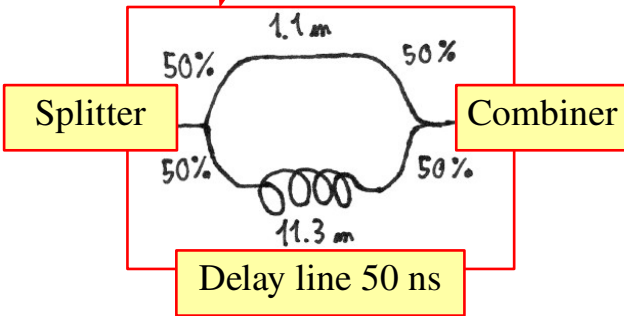


System time resolution:

$$\sigma_{\text{sys}}^2 = \sigma_{t1}^2 + \sigma_{t2}^2$$

$$\sigma_{\text{dut}}^2 = \frac{1}{2} \sigma_{\text{sys}}^2$$

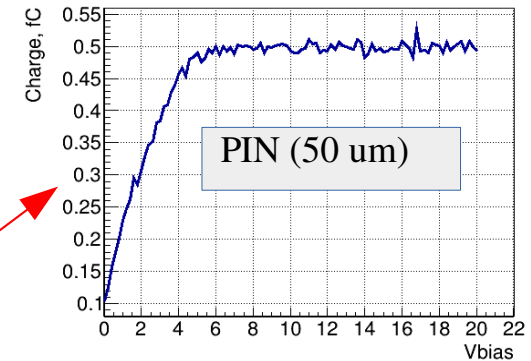
- ◆ **Time standard:** constant time interval between two picosecond IR laser pulses (1060 nm)
- ◆ Fixed time interval between laser pulses generated by optical splitting and delayed recombination of a single laser pulse.
- ◆ **External time reference is not needed.**



Gain definition:

$$G(V) = Q(V)_{\text{LGAD}} / Q_{\text{PIN}}$$

- \*  $Q_{\text{PIN}}$  and  $Q_{\text{LGADs}}$  are measured in the same conditions.
- \* IR-laser intensity calibrated to have 1 MIP equivalent:  
 $Q_{\text{PIN}}(V > V_d) \approx 0.5 \text{ fC}$  for a 50  $\mu\text{m}$  thick PIN.



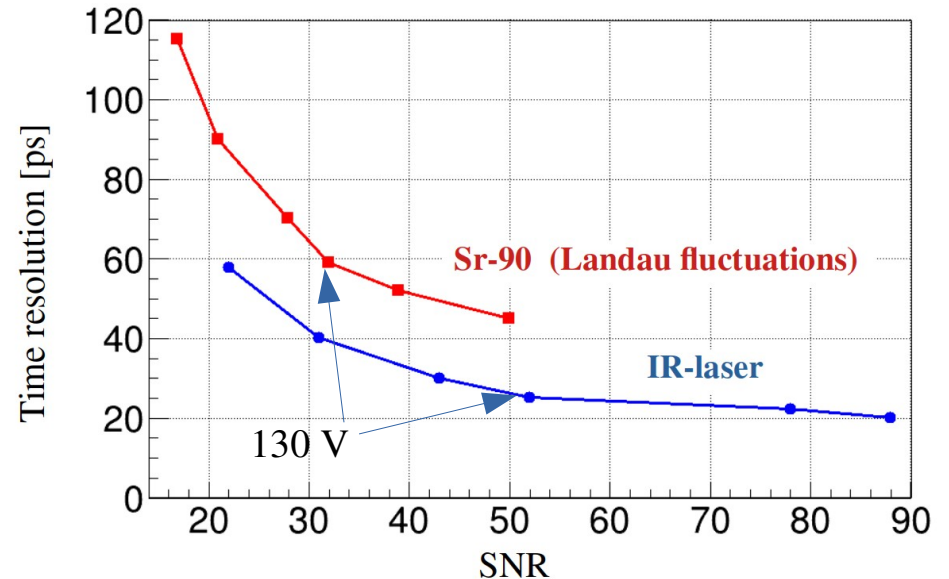
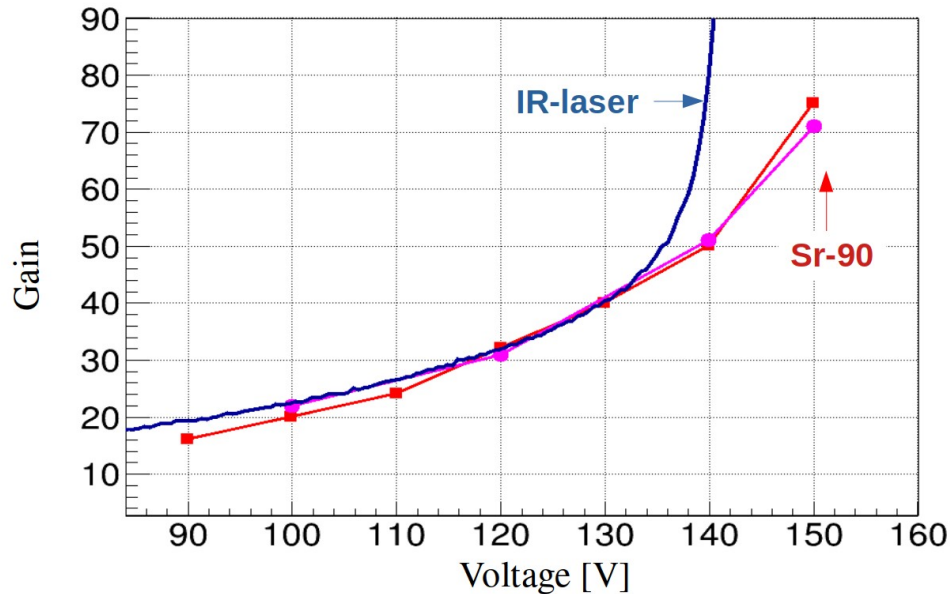
# Are IR-laser and Sr-90 measurements comparable ?

**Initial idea:** IR laser in TCT tuned to ~ 1 MIP to compare with Sr-90.

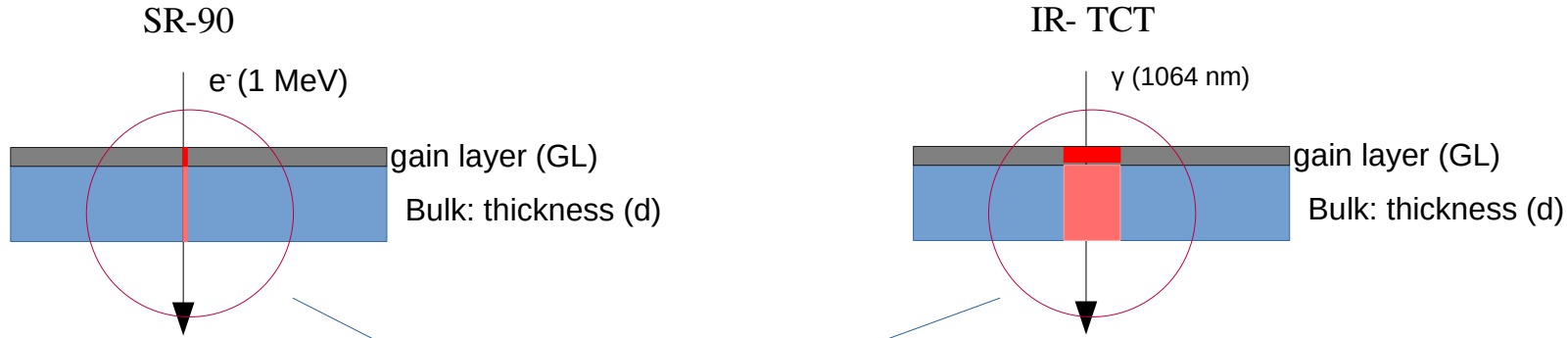
**Samples:** HPK2 and CNM 12916 (50 um thick devices of 1.3x1.3 mm<sup>2</sup> active area).

**Problems found:**

- Two identical sensors measured under the same conditions in TCT and RS-90 show different gain curves.
- Also the jitter measured in TCT is much lower than the time resolution measured in Sr-90.



# Differences between IR-TCT ( $\sim 1$ MIP ) and RS:



We generate the same amount of charge in both, but inside a different volume in the bulk:

With Sr-90 we have a much higher charge density because the ionizing path is narrower.

With the IR-laser we have less charge density, the ionizing “path” is wider: around 10  $\mu\text{m}$  in FWHM when focused.

## Hypothesis

Low charge density in the **GL** will lead to a higher gain: there will be a negligible gain suppression.

High charge density in the **GL** will lead to a reduction in the gain: drop in the GL E-field (less amplification).

# Study of the gain suppression mechanism with TCT IR-laser



# Increasing laser intensity in TCT:

T: +20 °C

Averaging: 1024

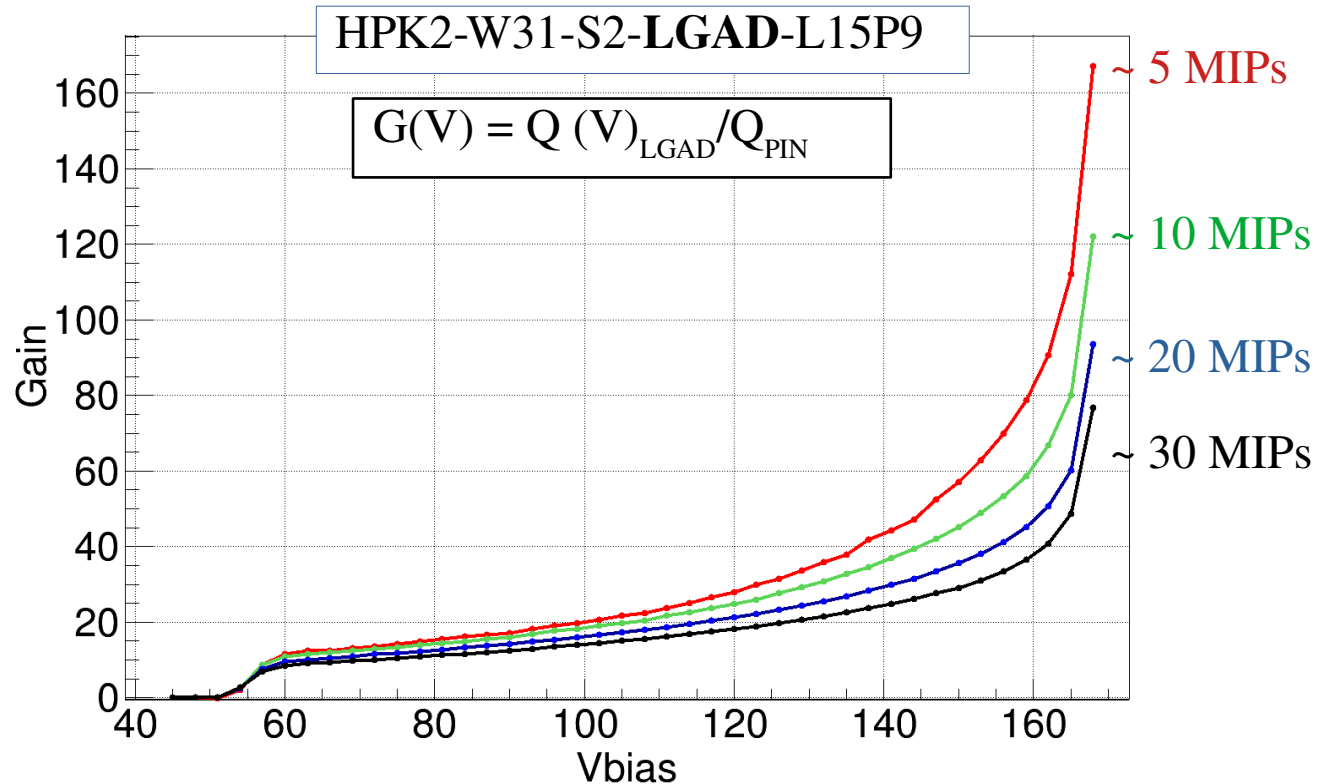
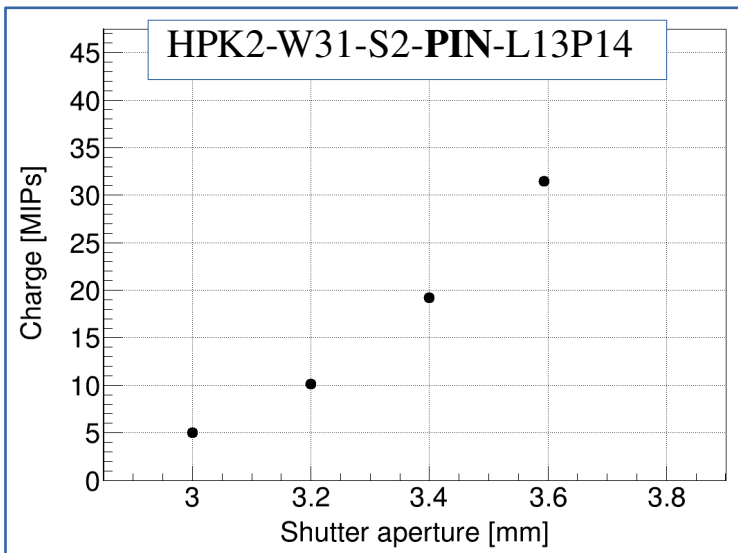
**No amplifier**

IR shutter aperture:

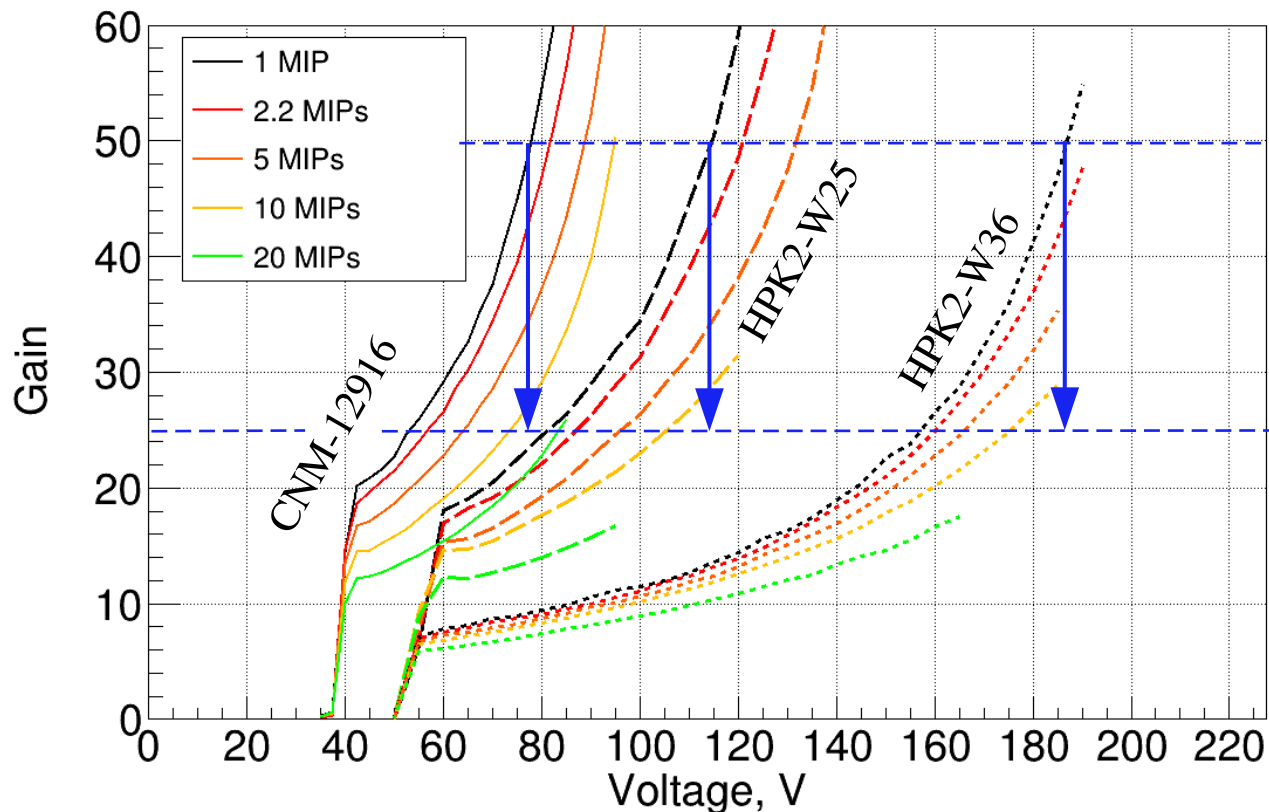
- 3.0 (~ 5 MIPs)
- 3.2 (~10 MIPs)
- 3.4 (~20 MIPs)
- 3.6 (~30 MIPs)

IR laser intensity  
(Charge density) ↑

Gain ↓



## TCT IR-laser: unirradiated



Measurements done at +20C

Gain suppression effect observed for all the 50 um LGADs that we studied.

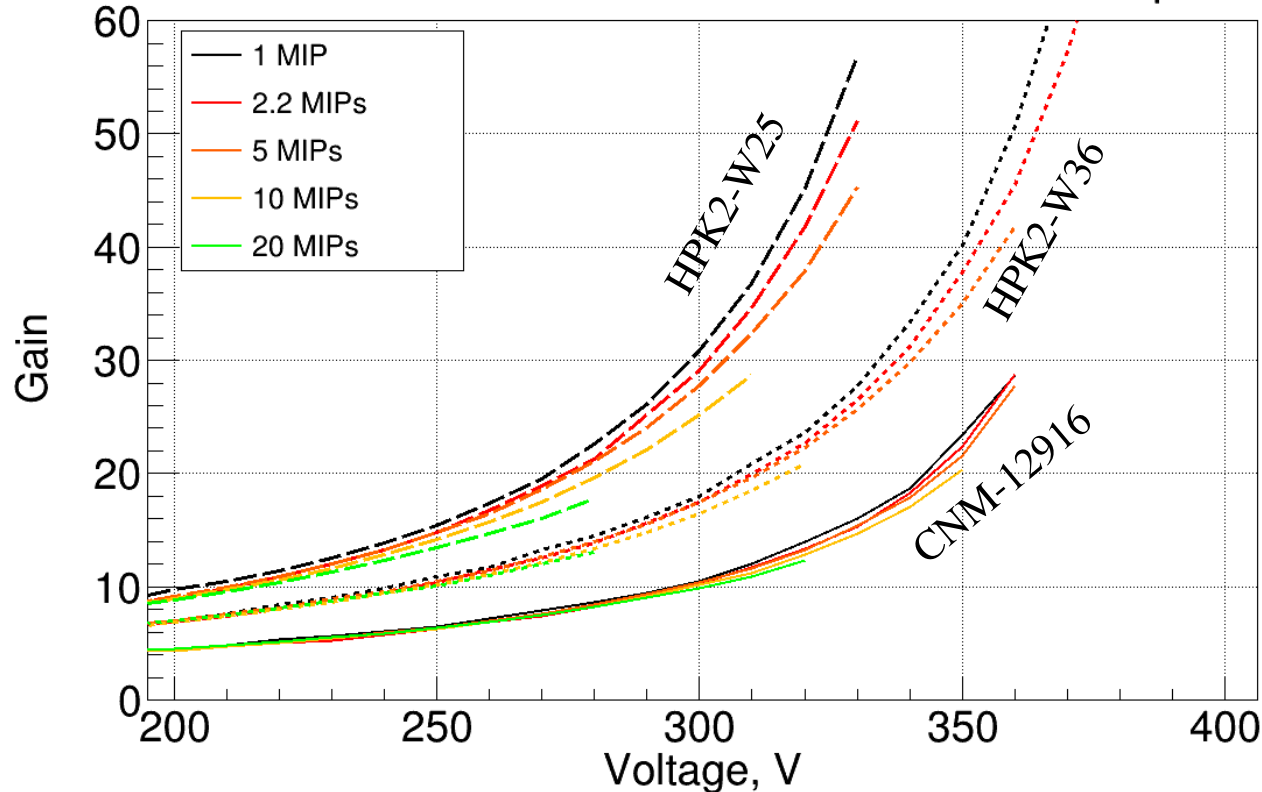
We observe a higher suppression for the LGADs with a higher nominal gain.

For all the samples: the higher the gain the higher the suppression, e.g:

- For a gain of 50 at 1 MIP the gain drops more than 50% for 20 MIPs.

# Different types of irradiated LGADs: $4 \times 10^{14} \text{ n}_{\text{eq}}/\text{cm}^2$

TCT IR-laser: neutron irradiated to  $4 \times 10^{14} \text{ n}_{\text{eq}}$



Measurements done at  $-20\text{C}$

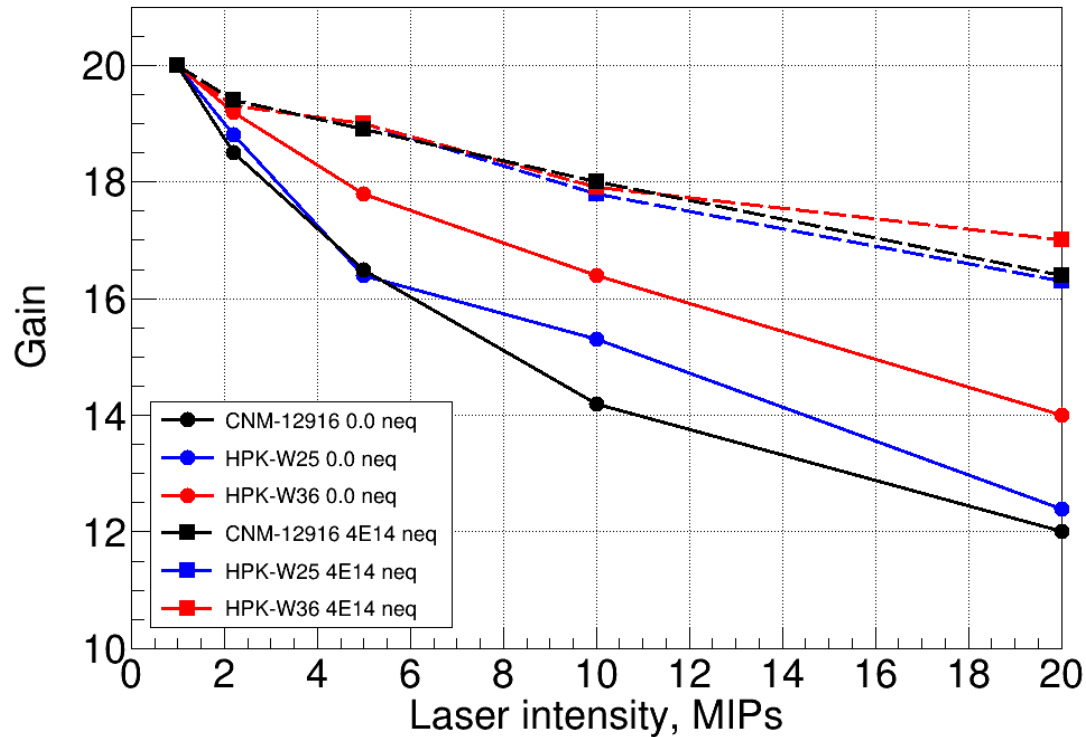
Gain suppression effect observed for all the 50  $\mu\text{m}$  irradiated LGADs to  $4 \times 10^{14} \text{ n}_{\text{eq}}$ .

The gain suppression is reduced with irradiation for all these devices.

For all the samples: the higher the gain the higher the suppression. But the effect is reduced w.r.t the non-irradiated ones.

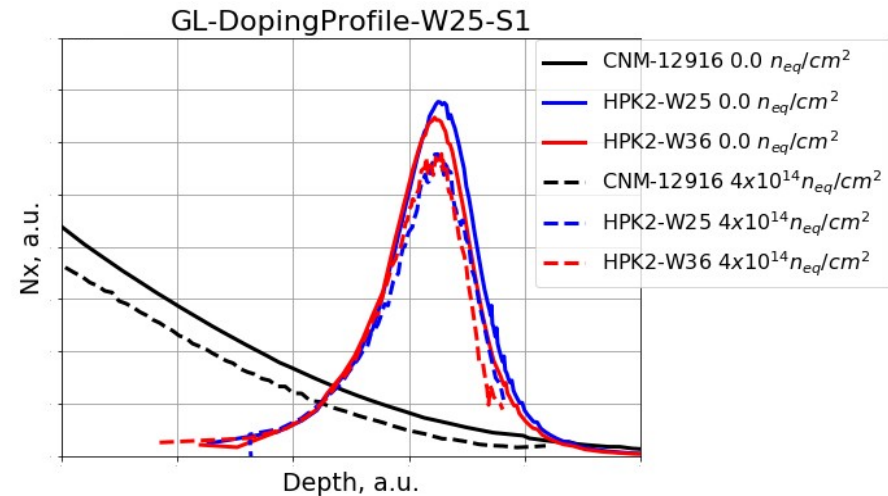
# Comparison: gain suppression for a gain of 20 (at 1MIP)

TCT IR-laser: G20 (1 MIP) suppression



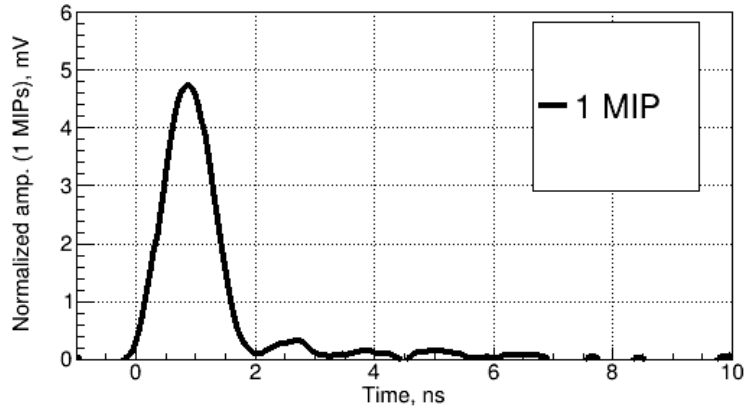
For a gain > 20, this reduction is more dramatic !

Gain suppression depends on the electric field distribution inside the detector.  
Each sample gets G20 at different reverse bias.  
Different doping profile!

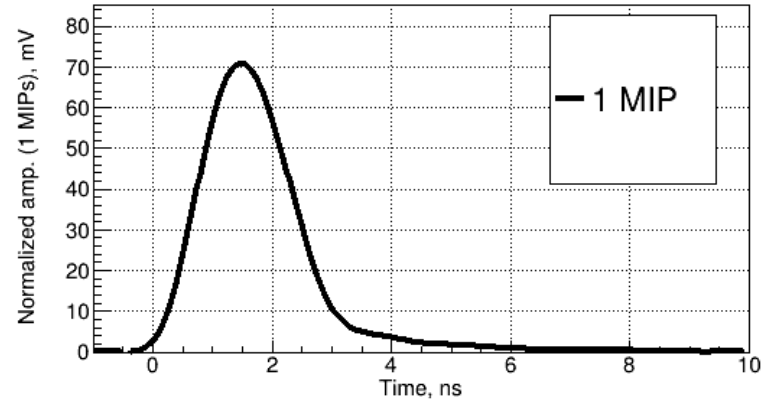


# TCT waveforms: non-irradiated LGAD-HPK2-W25

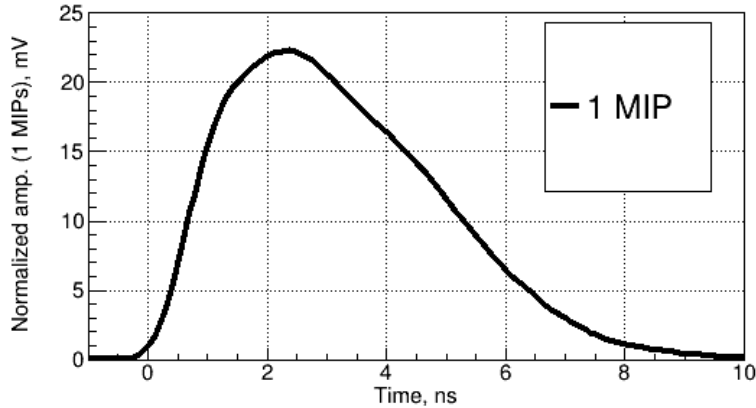
TCT IR-laser: waveforms PIN (Vbias: 50V)



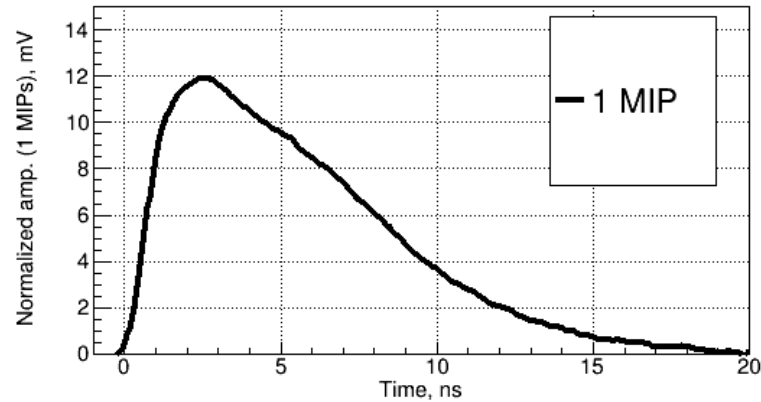
TCT IR-laser: waveforms LGAD (Vbias: 90V)



TCT IR-laser: waveforms LGAD (Vbias: 65V)

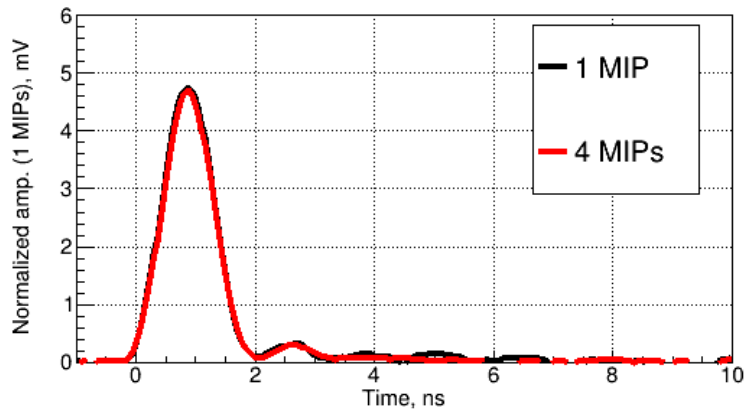


TCT IR-laser: waveforms LGAD (Vbias: 60V)

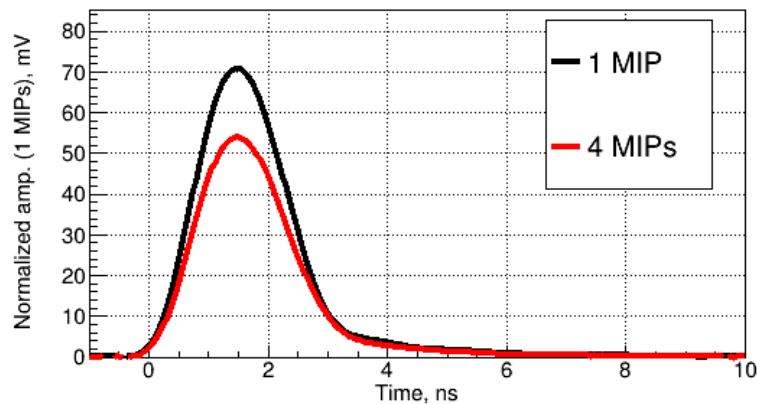


# TCT waveforms: non-irradiated LGAD-HPK2-W25

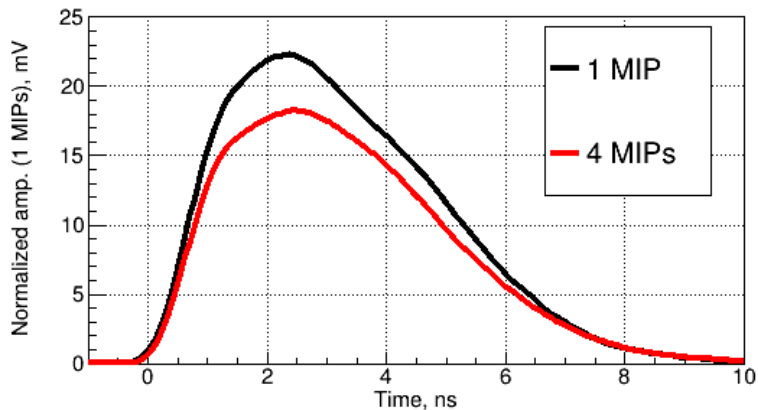
TCT IR-laser: waveforms PIN (Vbias: 50V)



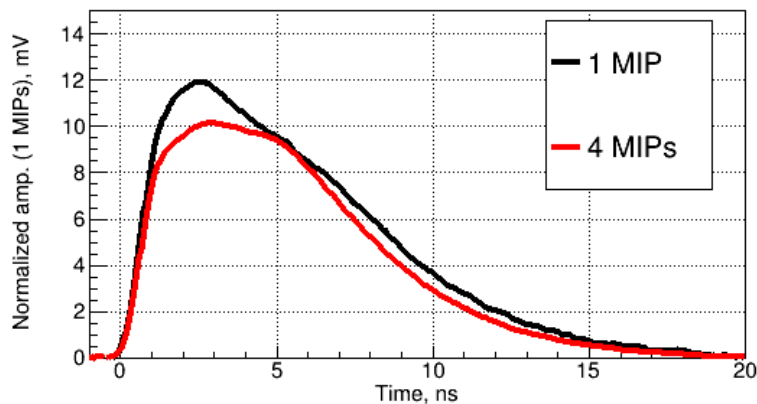
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TCT IR-laser: waveforms LGAD (Vbias: 65V)

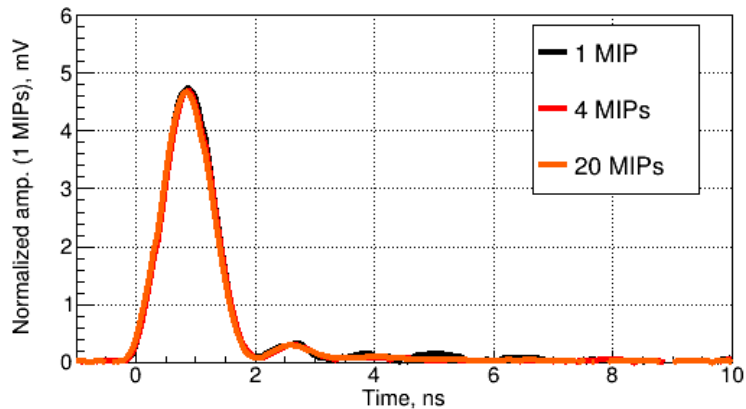


TCT IR-laser: waveforms LGAD (Vbias: 60V)

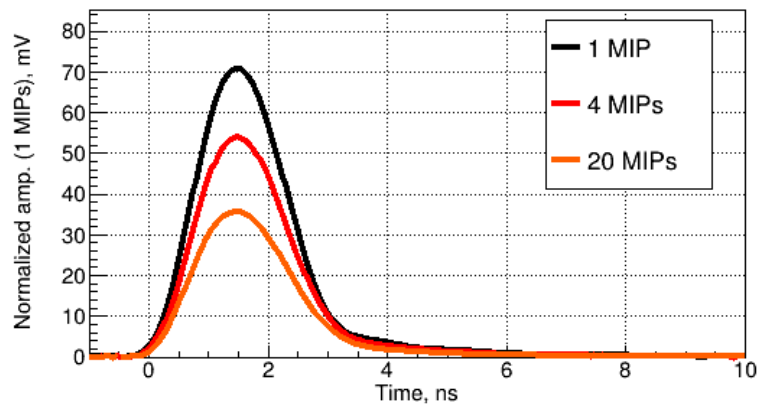


# TCT waveforms: non-irradiated LGAD-HPK2-W25

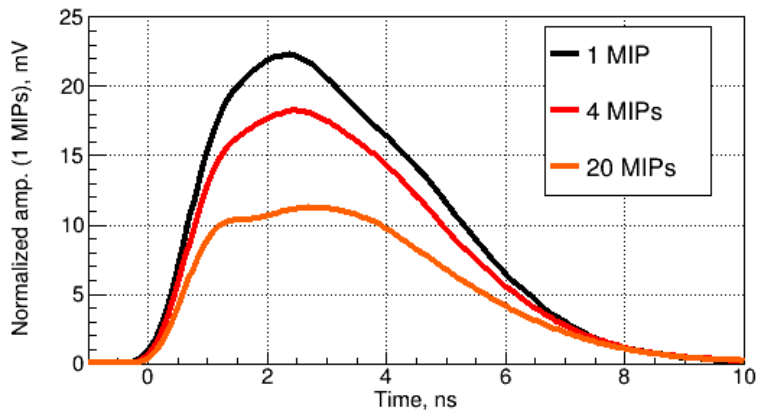
TCT IR-laser: waveforms PIN (Vbias: 50V)



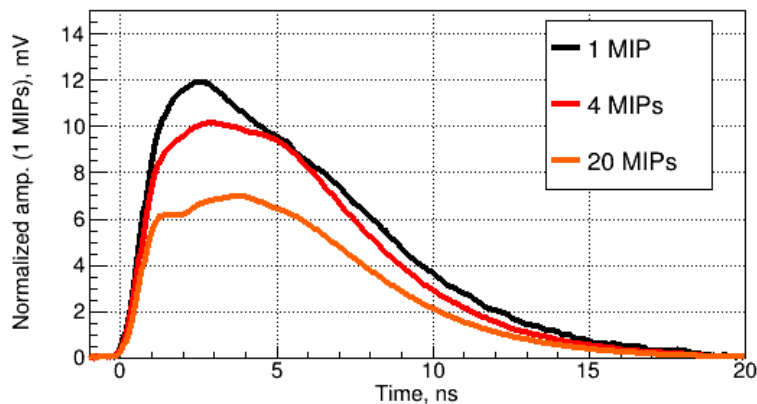
TCT IR-laser: waveforms LGAD (Vbias: 90V)



TCT IR-laser: waveforms LGAD (Vbias: 65V)

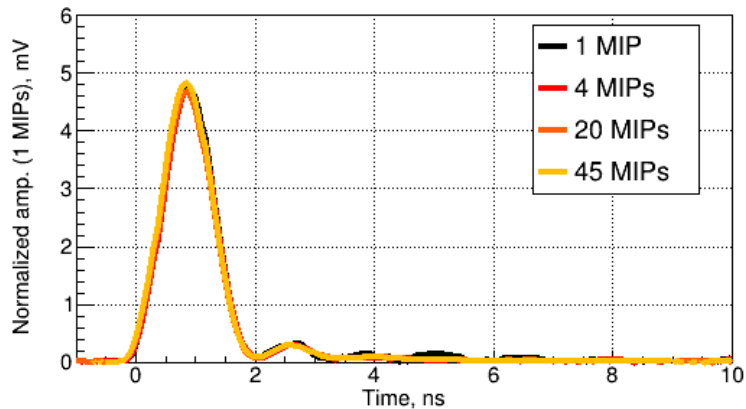


TCT IR-laser: waveforms LGAD (Vbias: 60V)

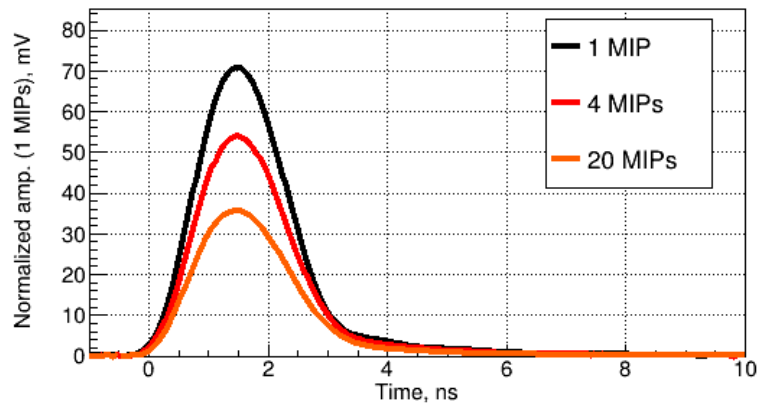


# TCT waveforms: non-irradiated LGAD-HPK2-W25

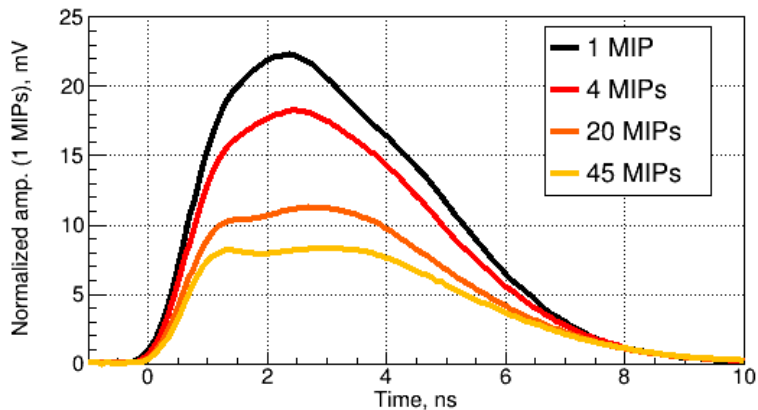
TCT IR-laser: waveforms PIN (Vbias: 50V)



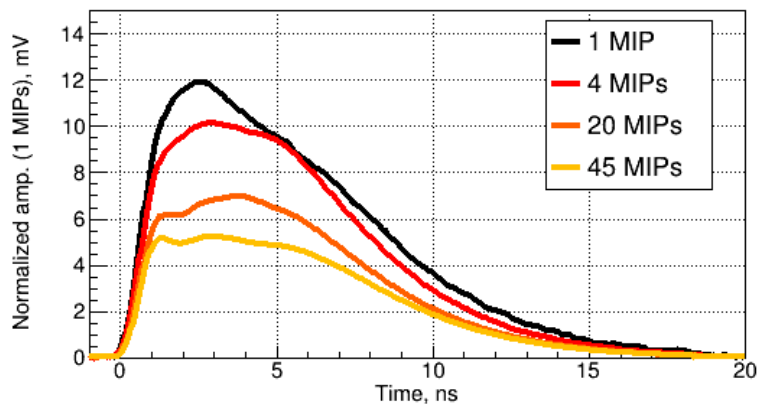
TCT IR-laser: waveforms LGAD (Vbias: 90V)



TCT IR-laser: waveforms LGAD (Vbias: 65V)



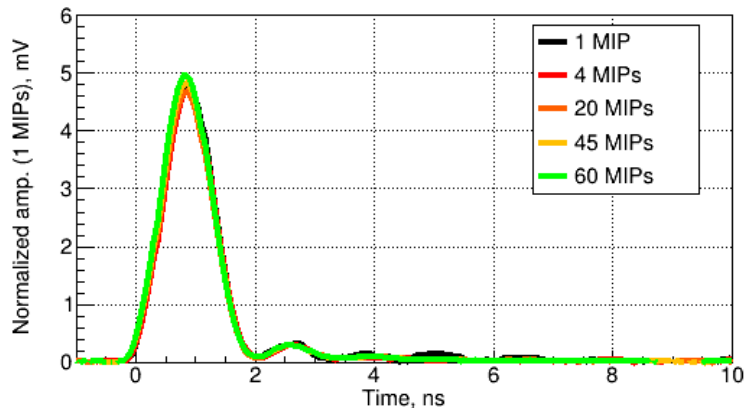
TCT IR-laser: waveforms LGAD (Vbias: 60V)



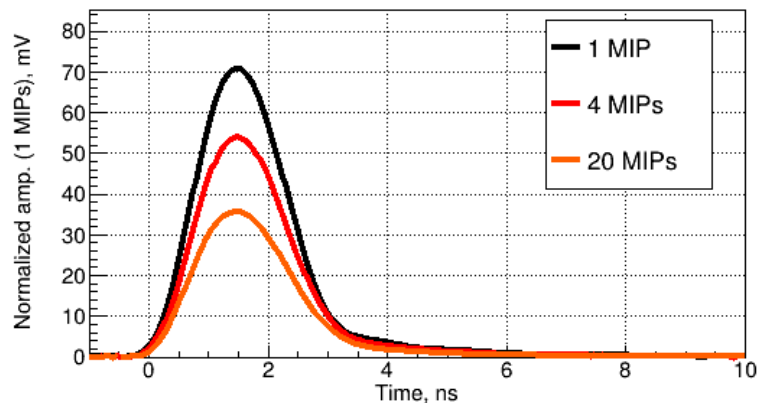


# TCT waveforms: non-irradiated LGAD-HPK2-W25

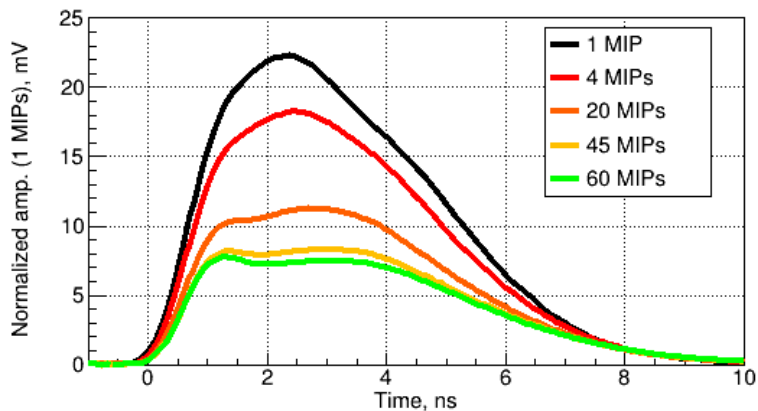
TCT IR-laser: waveforms PIN (Vbias: 50V)



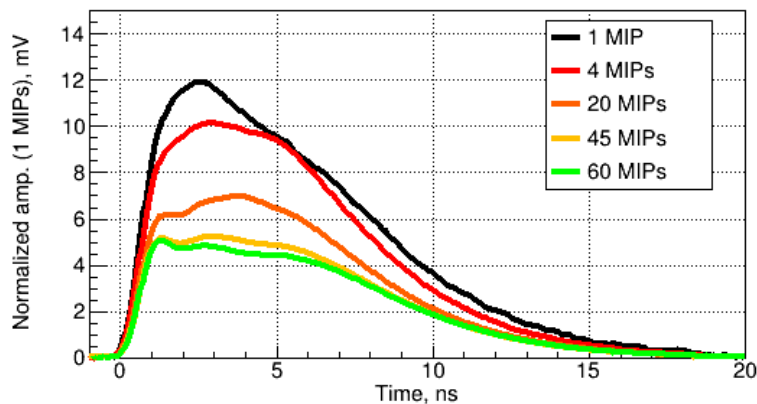
TCT IR-laser: waveforms LGAD (Vbias: 90V)



TCT IR-laser: waveforms LGAD (Vbias: 65V)



TCT IR-laser: waveforms LGAD (Vbias: 60V)

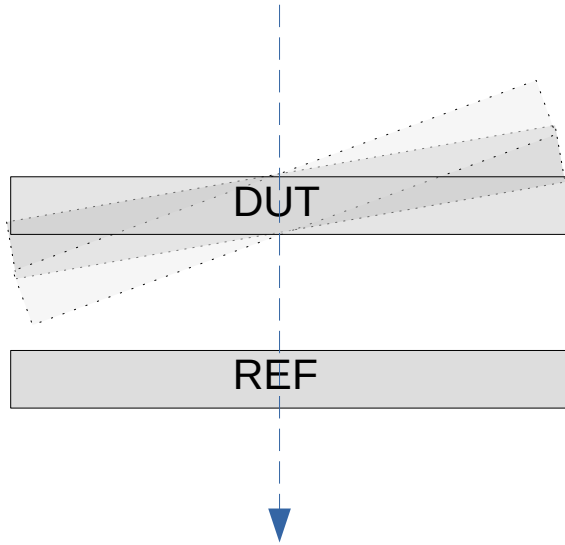


- Hint of saturation at 60 MIPs.
- No plasma observed.
- Gain reduction observed in the size of the pulses.
- Change in the pulse shape at low E-fields:
  - Reduction of the contribution of the secondary holes in the signal !

# Study of the gain suppression mechanism with Sr-90

# Sr-90 measurements: DUT tilted at different angles

Temperature constant at 20.0 deg

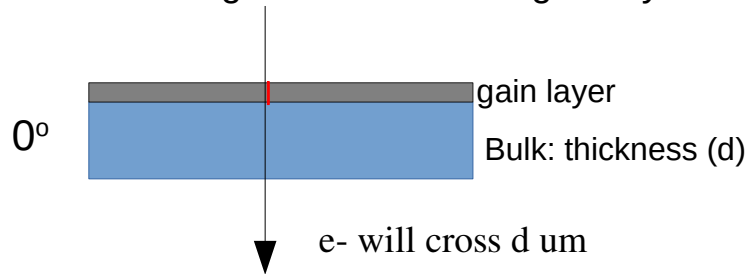


DUTs positioned at different angles: 0, ~7, ~14 deg

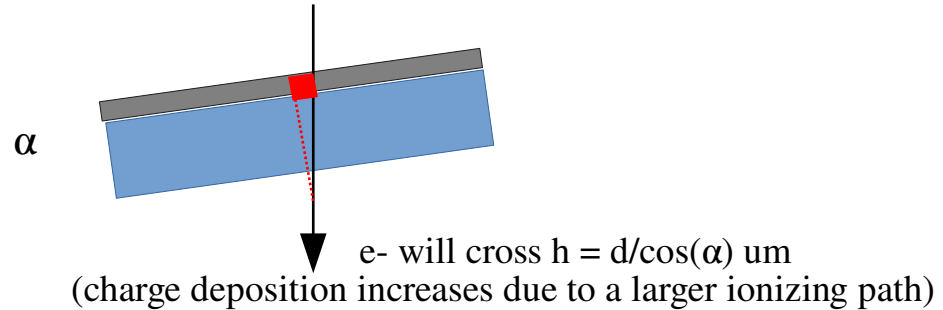
- HPK-P2-LGAD-W31-S2
- CNM-12916-W4-DB02

HPK-P2-LGAD-W42-S4: always the same sensor, not tilted and same  $V_{bias} = 180$  V.

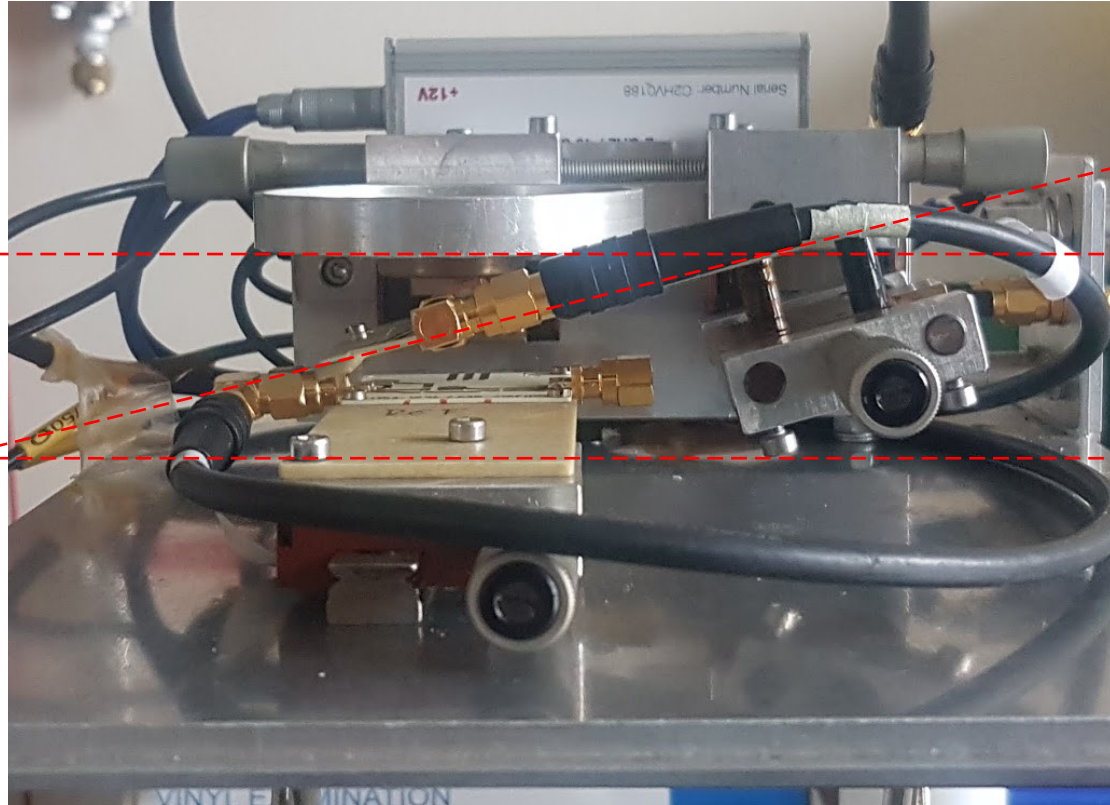
Narrow ionizing “area” under the gain layer.



Larger Ionizing “area” projected under the gain layer → less charge density in the amplification layer).



# Set-up picture at 14 deg



**DUT plane: 14 deg line**

**SR-90 plane**

**REF plane**

## **HPK**

- Bulk thickness  $d$ : 48  $\mu\text{m}$
- $h = d/\cos(14)$  : 49.47  $\mu\text{m}$  (+ 3.0 %)

## **CNM**

- Bulk thickness  $d$ : 42  $\mu\text{m}$
- $h = d/\cos(14)$  : 42.28  $\mu\text{m}$  (+ 3.0 %)

- Low Gain (low  $V_{\text{bias}}$ )  $\rightarrow$  low E-fields: low effect and we should be close to the 3.0% increase in the signal
- High Gain (high  $V_{\text{bias}}$ )  $\rightarrow$  high E-fields: high effect and we should see an increase in the charge higher than 3.0%

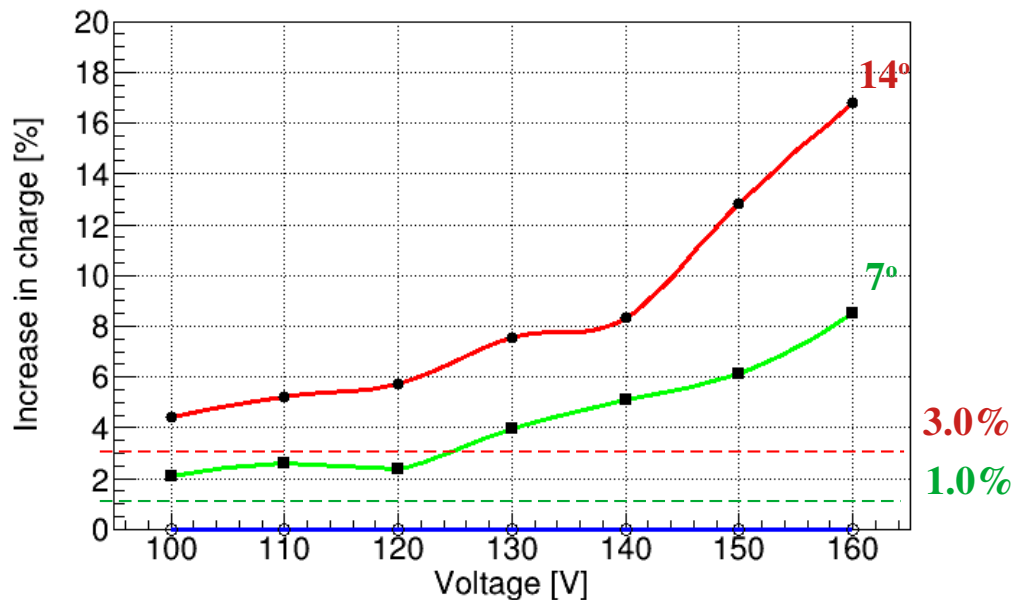
# Effect in the timing performance and charge

Summarizing Sr-90 results:

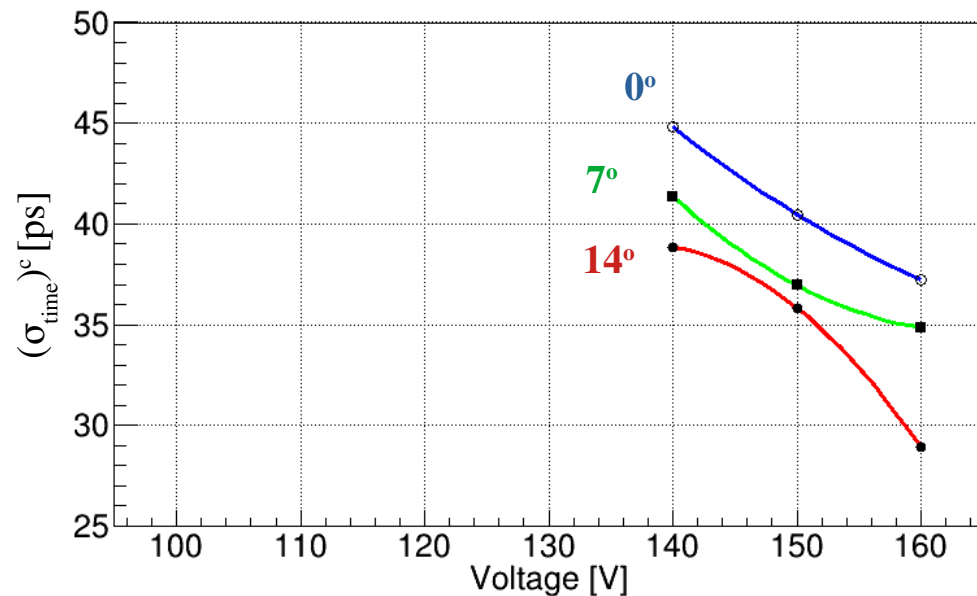
- Clear increase in the **charge collected** by tilting the sample.
- Clear improve in the **time resolution** by tilting the sample.

DUT: HPK2-W31-S2

Increase in Charge



Decrease in Time Resolution



- Discrepancies between IR-TCT and RS-90 were observed.
- They can be explained by the gain reduction produced for different charge densities inside the bulk under different conditions. This is affecting the impact ionization process in the gain layer:
  - ▷ RS generates a higher charge density → lower gain than IR-TCT.
  - ▷ Lower gain implies less charge collected → worse SNR and worse time resolution.
- Measurements in TCT and RS modifying the charge density were carried out to confirm it.
  - ▷ Effect observed for different types of LGADs.
  - ▷ Still present, but less accentuated, after neutron irradiation to  $4 \times 10^{14} n_{eq}/cm^2$ .
- Comparison of Gain and Charge measurements between TCT and RS set-ups is not straightforward.
- New parameter to keep under control: charge density. Especially important during the TCT measurements.

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**Thank you for your attention !**

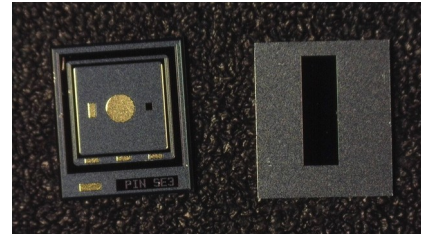
# Backup slides



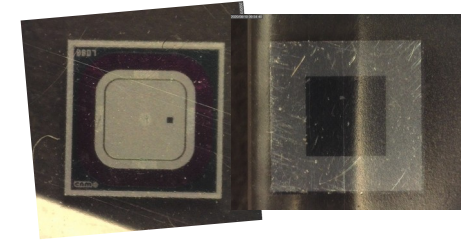
# IV measurements: LGADs

- Settings for HPK2 and CNM:
  - GR connected (except for the unirradiated HPK)
  - Temperature: -20 C (for all the irradiated)
  - Compliance: 10 uA

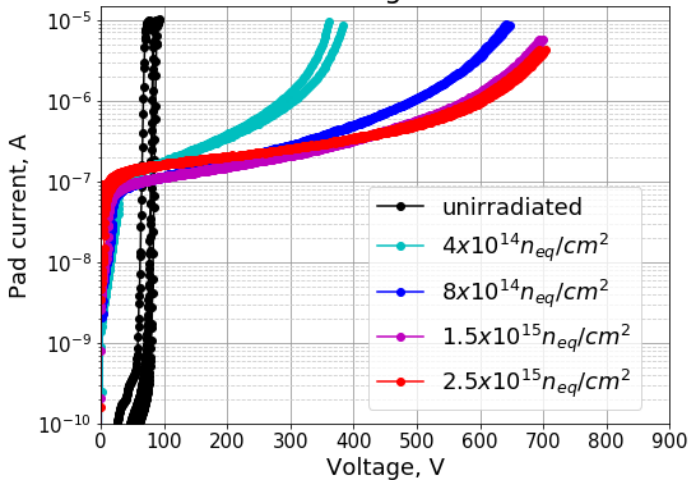
HPK2



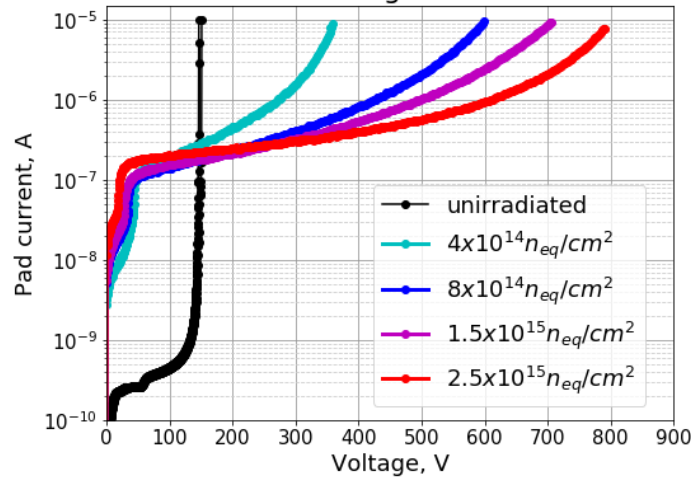
CNM



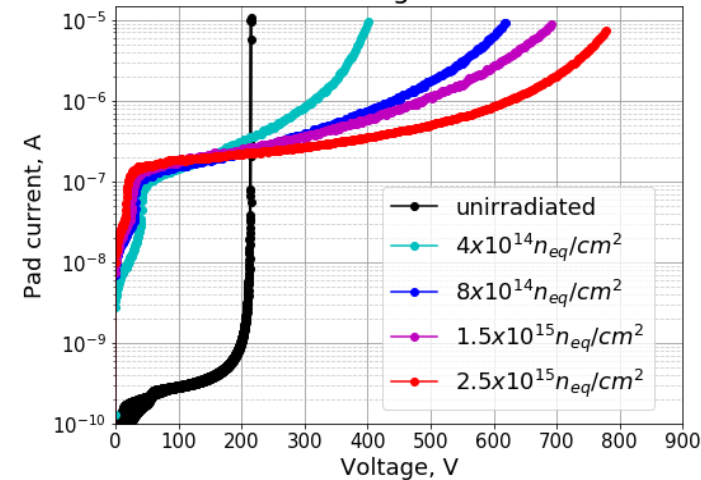
IV-CNM-Singles-12916



IV-HPK2-Singles-W25-S1

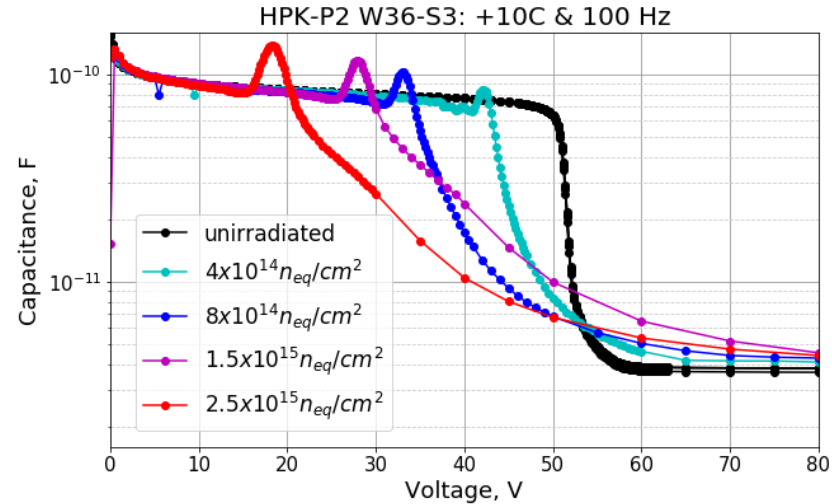
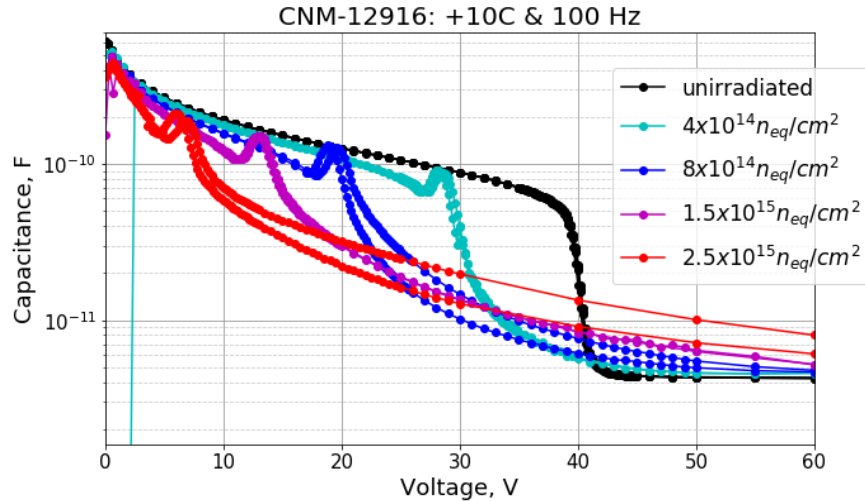
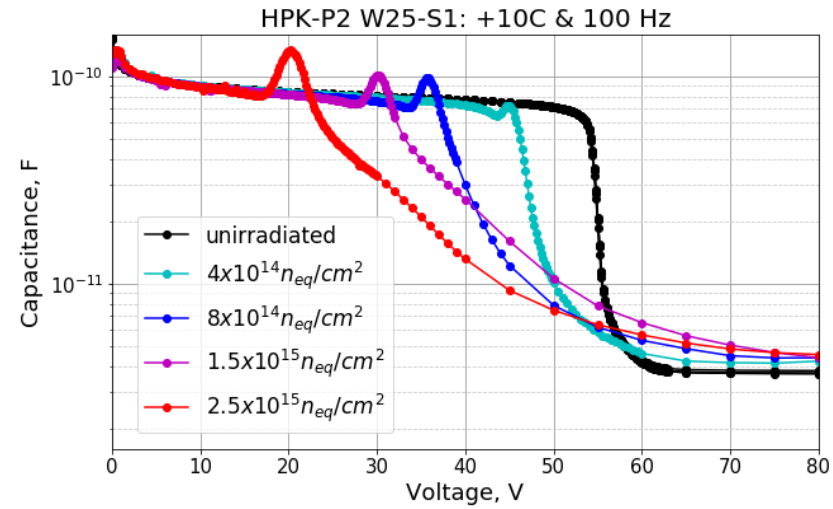


IV-HPK2-Singles-W36-S3



# CV measurements: LGADs

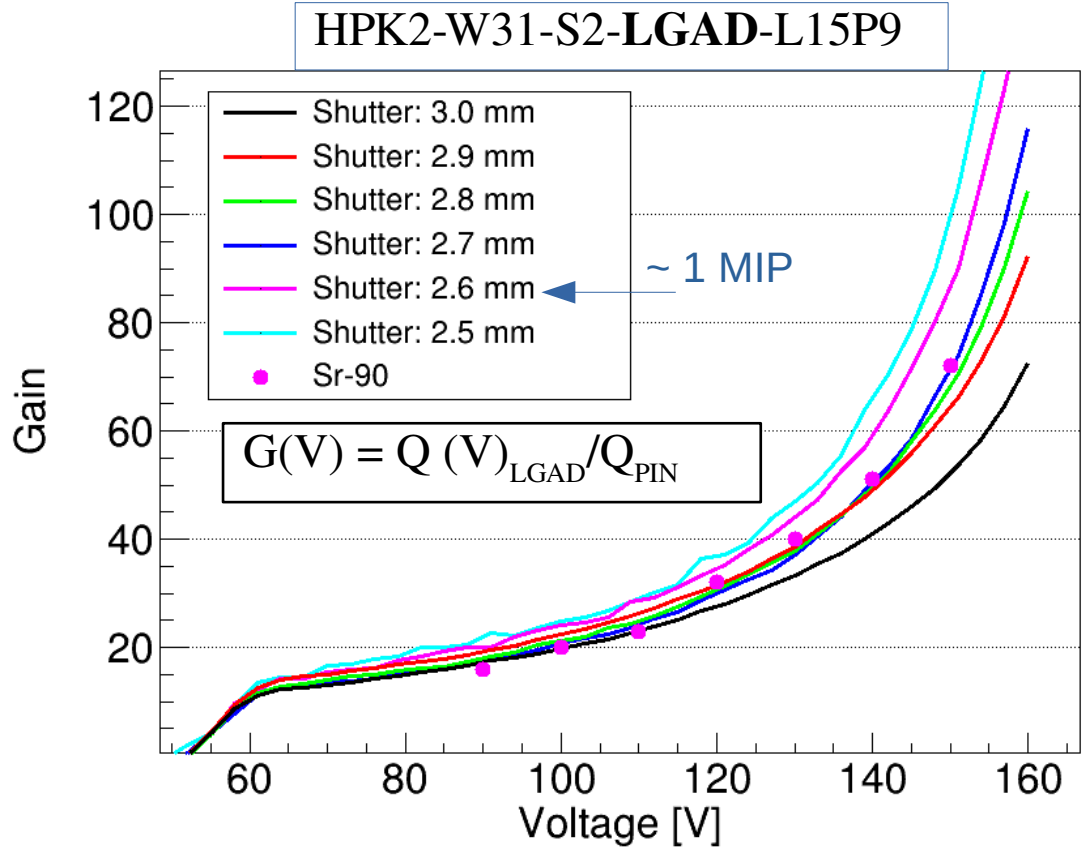
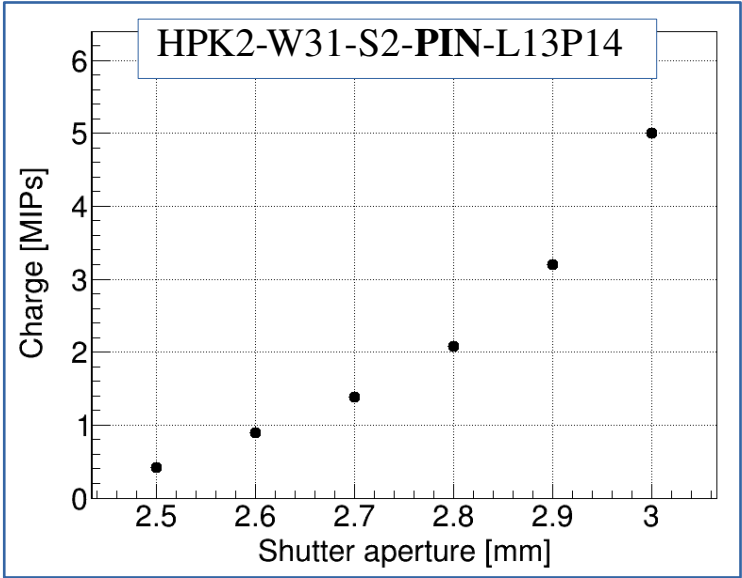
- Settings for HPK and CNM irradiated LGADs:
  - GR connected
  - Temperature: 10 C
  - Frequency: 100 Hz



# Decreasing laser intensity in TCT:

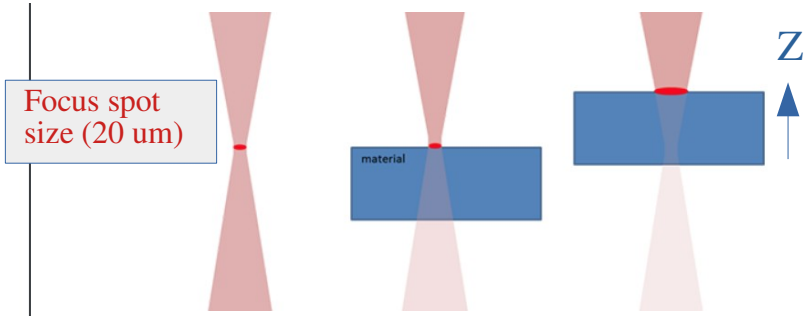
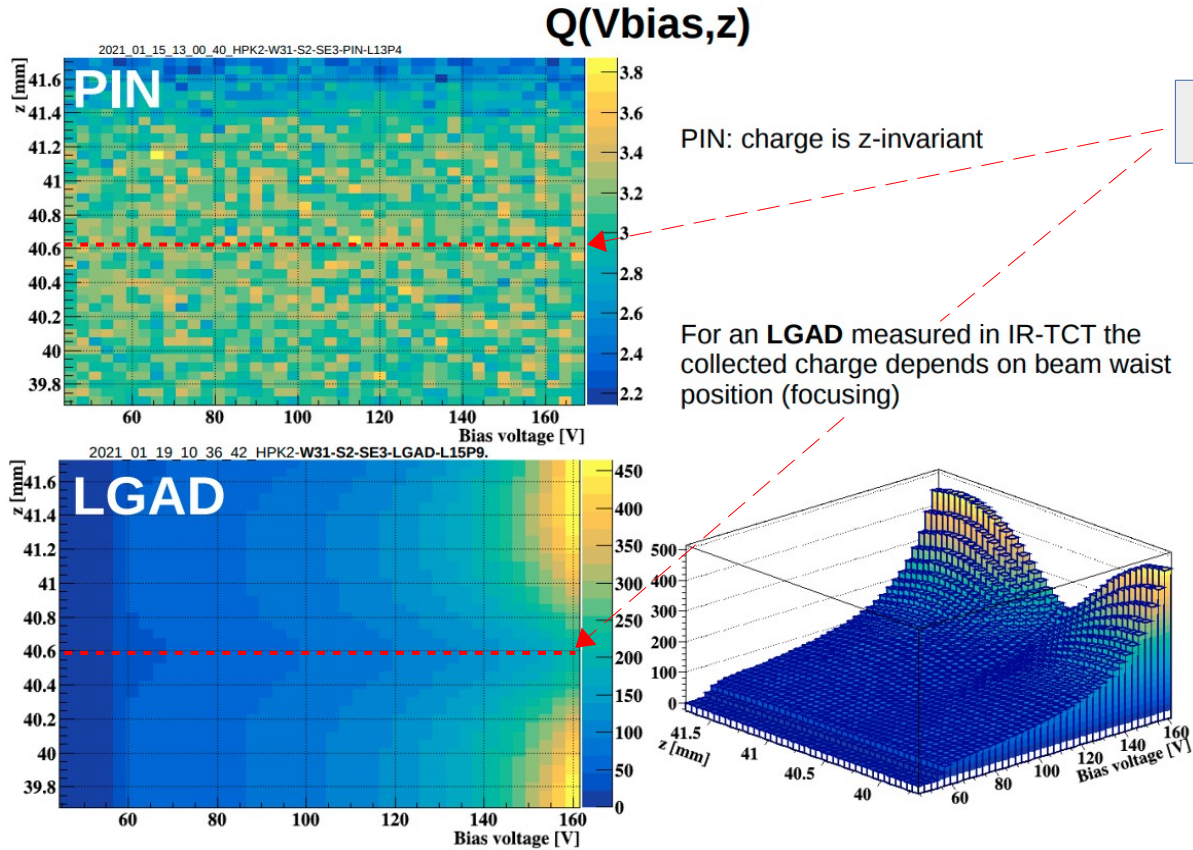
IR laser intensity ↓ Gain ↑

T: +20 °C  
Averaging: 1024  
Amplifier  
IR shutter aperture:  
• 3.0 (~ 5.0 MIPs)  
• ...  
• 2.5 (~ 0.4 MIPs)



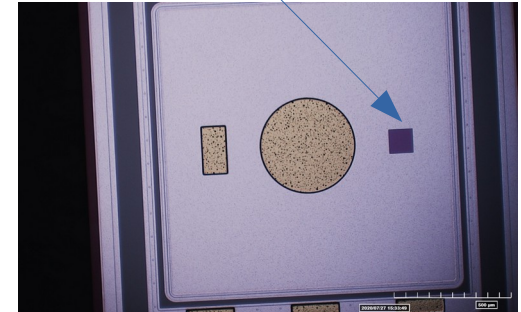
# Out-of-focus measurements

Charge density inside the detector can be changed by defocusing the laser.



Sketch not-to-scale

The laser beam is always inside the opening window in the metallization.  $100 \times 100 \mu\text{m}^2$

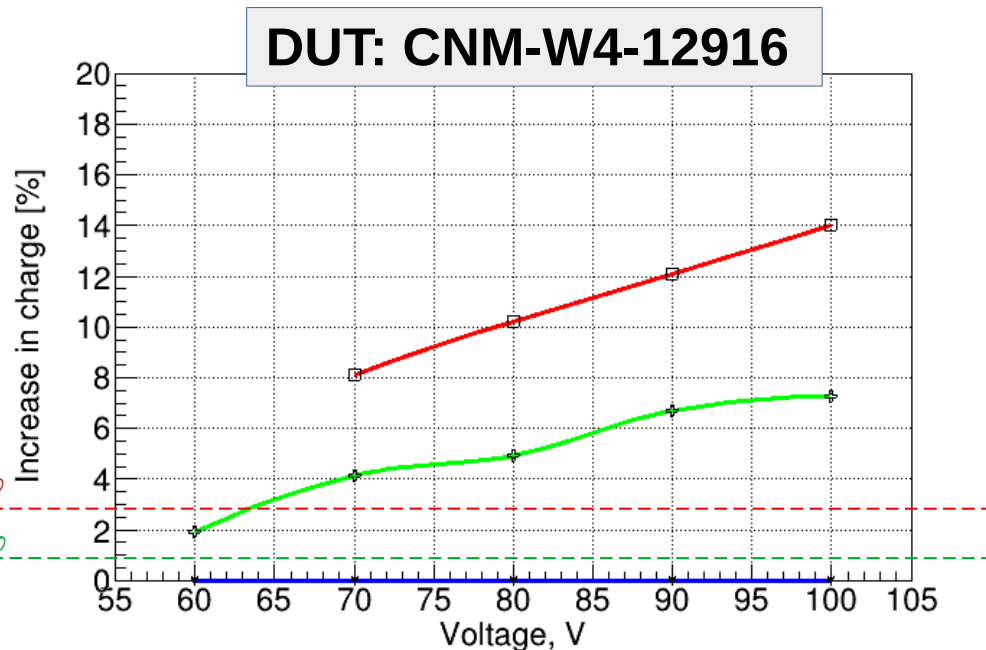
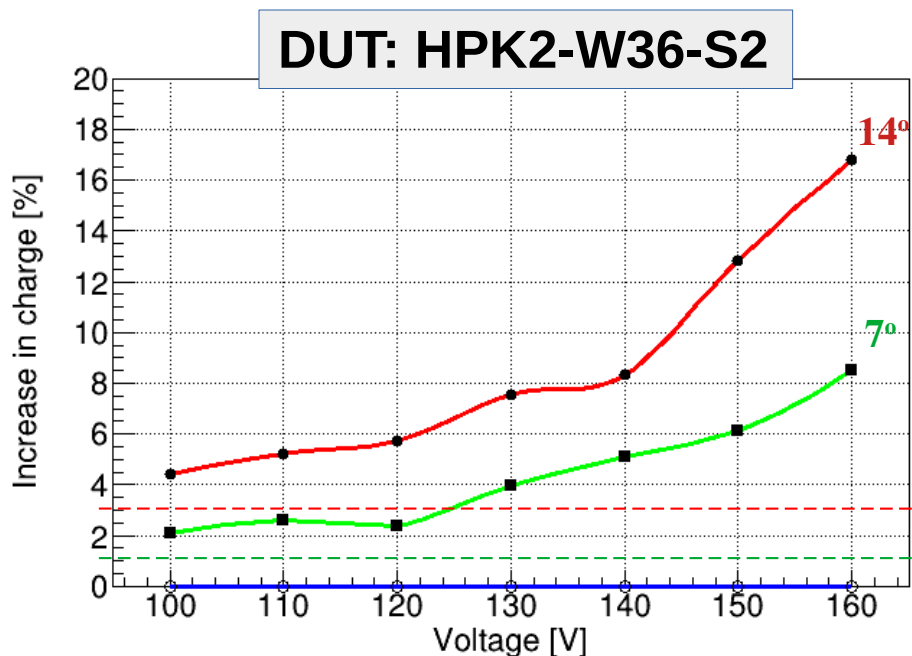


# Clear effect in the gain observed

Remarkably more charge collected by tilting the sample than expected by simple geometry.

Expected increase by only geometrical aspects marked with dotted lines:

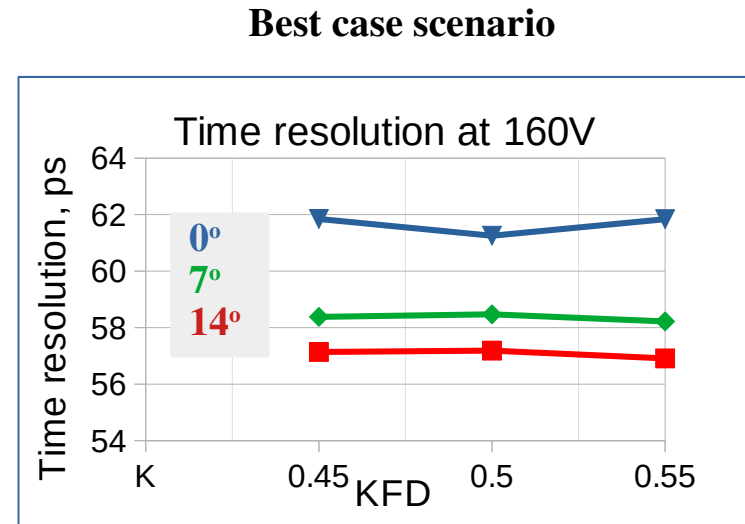
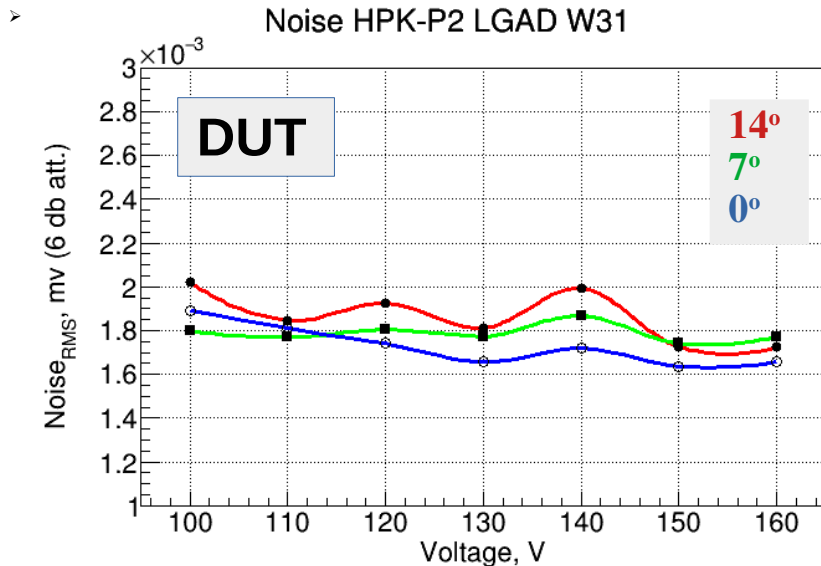
- 3.0 % for 14° and 1.0% for 7°.



# Effect in the timing performance

RS set-up still not optimized for low noise measurements. Not easy to measure because of the noise fluctuation between measurements:

- We have noise fluctuations between different measurements of almost 10 %.
- We can only measure the time resolution of the whole system ( DUT+REF) and it was dominated by REF.
  - The timing resolution of the REF has to be much lower than the DUT one.
  - Move to a three sensor configuration.

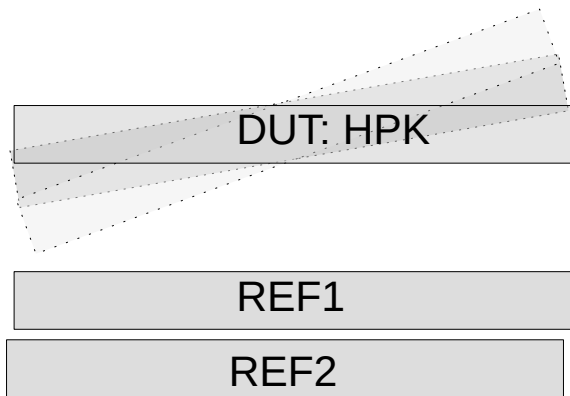


# Effect in the timing performance

## Measuring in a three sensors configuration !

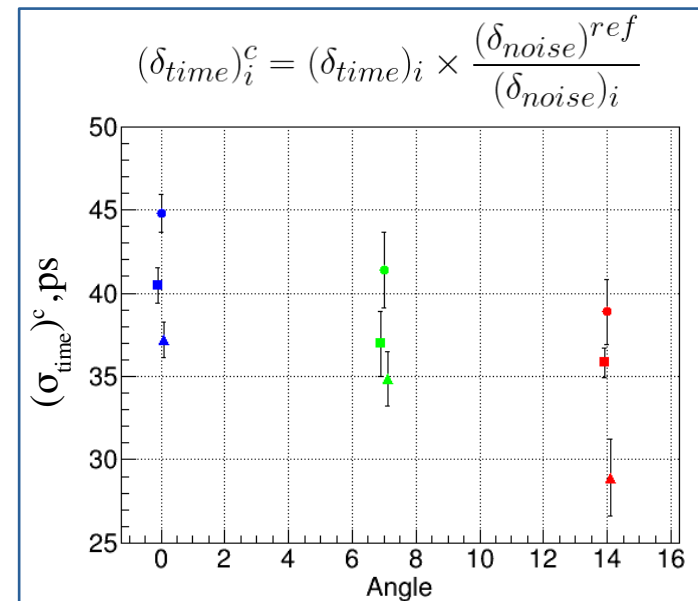
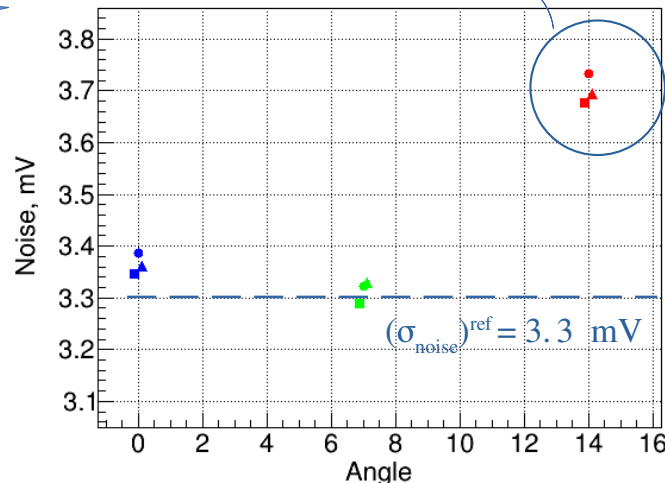
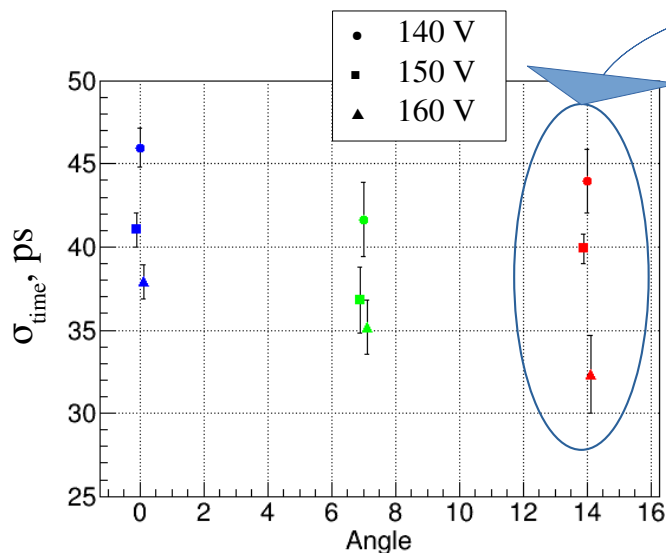
It is possible to get directly the time resolution of the DUT. It is less affected by noise fluctuations in the system in a two sensors configuration (DUT + REF).

$$\delta_{time} \propto \frac{\delta_{noise}}{\left| \frac{dV}{dt} \right|} \propto \frac{\Delta t}{\Delta V} * \delta_{noise} = \frac{\delta_{noise}}{SR}$$

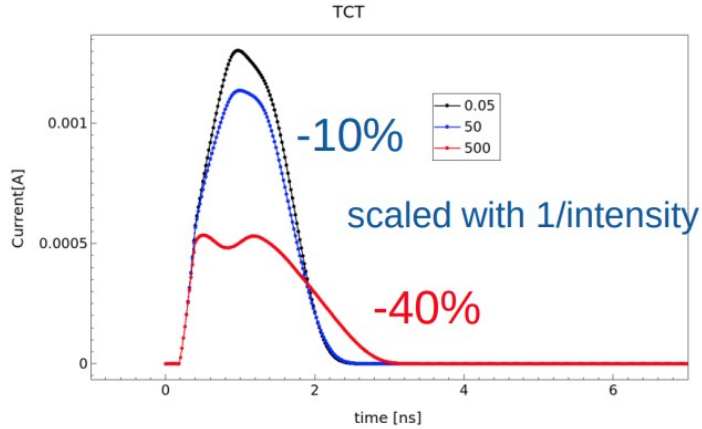


Higher noise!

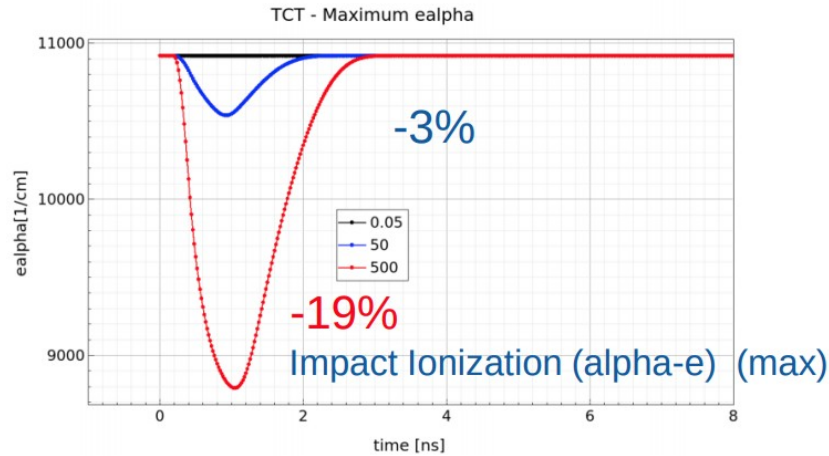
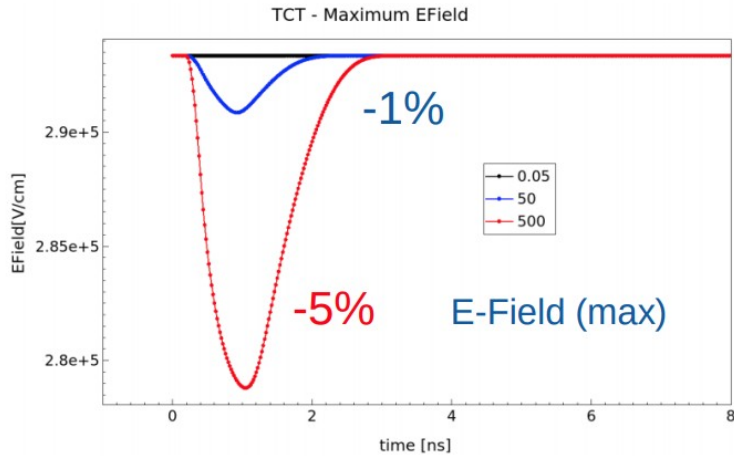
With noise correction



# 1-dim TCAD simulation: origin of the damping process?



- Carrier generation by impact ionization leads to reduction of Field strength
- Reduction of Field strength leads to reduction of impact ionization coefficient
- Reduction of impact ionization coefficient leads to less gain (i.e. signal reduction)



Beware: **very conservative!**  
1-dim model for a  
clearly 3-dim problem!